Patent Application



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

∕Douglas M. Albert, et al.

Serial No.: 09/770,864

Filed:/January 26, 2001

For:

A STACKABLE MICROCIRCUIT

LAYER FORMED FROM A
PLASTIC ENCAPSULATED
MICROCIRCUIT AND METHOD

OF MAKING THE SAME

Examiner: Hung V. Ngo

Group Art Unit: 2831

Irvine, California

January 15, 2002

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RESPONSE TO RESTRICTION REQUIREMENT

Assistant Commissioner for Patents Washington, DC 20231

Dear Sir:

In response to the Office Action mailed December 20, 2001, applicant hereby elects to prosecute group I., covering Claims 1 – 35.

Please feel free to contact the undersigned if you have any questions or comments.

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Box Fee Amendment, Assistant Commissioner for Patents, Washington, DC 20231 on January 15, 2002.

By Angela Williams

Signature

January /5, 2002

Respectfully submitted,

Joseph C. Andras

Redistration No. 33,469

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